



2021 Attendee List At-A-Glance

Company	Job Title
3M	SR. PRODUCT DEVELOPMENT SPECIALIST
ARCHRONIX	STAFF SIGNAL INTEGRITY ENGINEER
AGILENT TECHNOLOGIES	SR. STAFF SOFTWARE ENGINEER
ALPHAWAVE	VICE PRESIDENT
AMAZON	PRINCIPLE ENGINEER
AMAZON	HARDWARE DEVELOPMENT ENGINEER
AMPERE COMPUTING	SI/PI ENGINEER
APPLE	ENGINEER
APPLE	ELECTRICAL ENGINEER (SI/PI)
ARISTA NETWORKS	LEAD EMC DESIGNER
ARISTA NETWORKS	SOFTWARE TEST ENGINEER
ARISTA NETWORKS	MECHANICAL ENGINEER
ARISTA NETWORKS	HARDWARE ENGINEER
ASTERA LABS	VP OF PRODUCTS
AVERATEK CORP.	VP, ENGINEERING
AWS	COMPONENT ENGINEER
BARAJA	DEVELOPMENT ENGINEER
BO ENGINEERING SERVICES	FIELD APPLICATIONS ENGINEER
BOYD CORP.	FIELD APPLICATIONS ENGINEER
BROADCOM	PRODUCT MANAGER
BROADCOM	ENGINEER
BROADCOM	HARDWARE ENGINEER
BROADCOM	DISTINGUISHED ENGINEER
BROADCOM	R&D MANAGER
CADENCE	DIRECTOR
CADENCE	PRINCIPAL APPLICATION ENGINEER
CADENCE	SR. SYSTEMS ARCHITECT
CADENCE	SR. DESIGN ENGINEERING MANAGER
CISCO	ENGINEER
CISCO	SR. MECHANICAL ENGINEER
CISCO	THERMAL ENGINEER
CISCO	SI ENGINEER
CISCO	PRINCIPAL ENGINEER
CISCO	PRODUCT ENGINEER TECH LEAD
CISCO	SR. MANUFACTURING ENGINEER
CISCO	SR. SIGNAL INTEGRITY MANAGER
CISCO	ENGINEERING LEAD
CODAR OCEAN SENSORS	PRODUCTION TEST ENGINEER

Company	Job Title
CYBERDATA CORP.	EMBEDDED SOFTWARE ENGINEER
DELL	HARDWARE ENGINEER
DISH	SR. HARDWARE DESIGN ENGINEER
DUPONT	INNOVATION CENTER LEADER
DUPONT	TECHNICAL MANAGER
ETOPUS TECHNOLOGY	ANALOG DESIGN ENGINEER
ETOPUS TECHNOLOGY	PRINCIPAL ENGINEER
FACEBOOK	PHYSICAL DESIGN ENGINEER
FACEBOOK	SIPI ENGINEER
FACEBOOK	HARDWARE ENGINEER
FUSHION-BIOTEC, INC.	SR. SOFTWARE ENGINEER
GOOGLE	SOFTWARE DEVELOPER
GOOGLE	ENGINEERING MANAGER
GOOGLE	STRATEGIC SEMICONDUCTOR MANAGER
GOOGLE	SR. SIGNAL INTEGRITY & POWER INTEGRITY MANAGER
GOOGLE	MANUFACTURING ENGINEER
GOOGLE	CHIP PACKAGE DESIGN ARCHITECT
GRADIENT INC.	EMBEDDED SYSTEMS ENGINEER
HIROSE ELECTRIC U.S.A.	APPLICATION ENGINEER
HIROSE ELECTRIC U.S.A.	PRINCIPAL ENGINEER IN PHOTONIC SI
II-VI INCORPORATED	SR. MECHANICAL ENGINEER
INTEL	VALIDATION ENGINEER
INTEL	R&D MANAGER
INTEL	DESIGN ENGINEER
INTEL	TECHNOLOGIST
INTEL	ENGINEER
INTEL	DESIGN ENGINEER
INTEL	LEAD DEVICE INTEGRATION ENGINEER
INTEL	PRINCIPAL SI ENGINEER
INTEL	HARDWARE ENGINEER
INTEL	PACKAGING R&D ENGINEER
INTUITIVE	R&D MANAGER
I-PEX	FIELD APPLICATIONS ENGINEER
JUNIPER NETWORKS	EMC DESIGN ENGINEER
JUNIPER NETWORKS	SR. DISTINGUISHED ENGINEER
JUNIPER NETWORKS	PCB/INTERCONNECT TECHNOLOGIST
JUNIPER NETWORKS	SR. STAFF ENGINEER
JUNIPER NETWORKS	HARDWARE ENGINEER
KEYSIGHT TECHNOLOGIES	MASTER SI ENGINEER



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attendee objective is to keep up-to-date with market trends/see new products and innovations in-person, and network among the industry face-to-face.



90% of attendees recommend, specify, or make the final buying decision

Company	Job Title
KEYSIGHT TECHNOLOGIES	SI/PI APPLICATIONS ENGINEER
KLA	ELECTRICAL DESIGN ENGINEER
LATTICE SEMICONDUCTOR	DESIGN ENGINEER
LITHIUMANIAC	BIOMEDICAL ENGINEER
LUXSHARE-ICT	PRODUCT APPLICATION ENGINEER
MARVELL SEMICONDUCTORS INC.	SR. SYSTEM ENGINEERING DIRECTOR
MAXSON GROUP	SR. MOTION CONTROLS ENGINEER
MENTOR, A SIEMENS BUSINESS	PRINCIPAL ENGINEER
MERCURY SYSTEMS	SIGNAL INTEGRITY ENGINEER
MICROCHIP TECHNOLOGY	TECHNICAL ARCHITECT
MICRON TECHNOLOGY INC.	PRINCIPAL ENGINEER
MICROSOFT	HARDWARE ENGINEER
MICROSOFT	PRINCIPAL ENGINEER
MKS INSTRUMENTS INC.	SR. ELECTRONICS ENGINEER
MOLEX LLC	SR. PROJECT ENGINEER
NITTO DENKO AMERICA	DESIGNER
NOKIA	HARDWARE ENGINEER
NVIDIA	SR. STAFF SIGNAL INTEGRITY ENGINEER
NVIDIA	SR. DIRECTOR OF HARDWARE
NVIDIA	SR. PCB DEVELOPMENT ENGINEER
NVIDIA	MANAGER, MISED SIGNAL DESIGN
OMRON ROBOTICS AND SAFETY TECHNOLOGIES	ELECTRICAL ENGINEER
ORACLE	PRINCIPAL HARDWARE ENGINEER
ORACLE	COMPONENT ENGINEER
ORACLE	PRINCIPLE COMPONENT ENGINEER
ORACLE	DESIGN ENGINEER
ORACLE	SR. PRINCIPAL COMPONENT ENGINEER
POWDERTECH INTERNATIONAL	VICE PRESIDENT
QUALCOMM	ENGINEER
QUALCOMM	SR. STAFF ENGINEER/MANAGER
RAYTHEON	SR. ENGINEER
ROHDE & SCHWARZ	FIELD ENGINEER
ROKU	SR. HARDWARE ENGINEER
SAMSUNG	SENIOR STAFF ENGINEER

Company	Job Title
SAMSUNG ELECTRONICS	DIRECTOR, PACKAGE AND SI/PI ARCHITECT
SAMSUNG SEMICONDUCTOR INC.	PRINCIPAL ENGINEER
SAMTEC	MECHANICAL ENGINEER
SAMTEC	GLOBAL ENGINEERING ADVISOR
SANDIA LABS	ELECTRONICS ENGINEER
SANMINA	SR. QUALITY ENGINEER
SANMINA	DESIGN ENGINEER
SEAGATE	MANAGER
SEAGATE	STAFF PACKAGING ENGINEER
SEAKR ENGINEERING	SR. SI & PI ENGINEER
SIEMENS EDA	APPLICATION ENGINEER
SIEMENS EDA	PRODUCT MARKETING MANAGER
SPECTRA-PHYSICS	PRINCIPAL ELECTRICAL ENGINEER
STMICROELECTRONICS	SERDES APPLICATION ENGINEER
SYNAPTICS INC.	SR. STAFF SYSTEM DESIGN ENGINEER
SYNOPTIS	SILICON VALIDATION ENGINEER
TDK	SYSTEM HARDWARE ENGINEER - SR. STAFF
TE CONNECTIVITY	FIELD APPLICATION ENGINEER
TE CONNECTIVITY	TECHNOLOGIST, SYSTEM ARCHITECTURE TEAM
TEKTRONIX	SR. FIELD APPLICATION ENGINEER
TEKTRONIX	DIRECTOR OF PLATFORMS
TEKTRONIX	PRINCIPAL ENGINEER
TELEDYNE FLIR	SR. SOFTWARE ENGINEER
TELEDYNE LECROY	HARDWARE ENGINEER
TESLA	ENGINEER
TEXAS INSTRUMENTS	ANALOG DESIGN ENGINEER
TEXAS INSTRUMENTS	SYSTEMS ENGINEER
VARIAN	HARDWARE DESIGN ENGINEER
VIKING ENTERPRISE	SR. SIGNAL INTEGRITY ENGINEER
WESTERN DIGITAL	SIGNAL INTEGRITY & EMC TECHNOLOGIST
WESTERN DIGITAL	EMC AND SIGNAL INTEGRITY ENGINEER
XILINX	SR. STAFF PACKAGING ENGINEER
XILINX	COMPONENT ENGINEER
XILINX	PRINCIPAL ENGINEER/ARCHITECT
XILINX	DISTINGUISHED ENGINEER & SUPERVISOR
YAMAICHI ELECTRONICS USA	DIRECTOR
ZAP SURGICAL	PRINCIPAL ENGINEER

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